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Application No.: 09/931330

Docket No.: 05587-00318-US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Frank Reil

Application No.: 09/931330

Group Art Unit: 1714

Filed: August 16, 2001

Examiner: C. E. Shosho

For: THERMOPLASTIC MOLDING
COMPOSITION AND ITS USE FOR LASER
WELDING

COMMUNICATION IN RESPONSE TO INTERVIEW SUMMARY

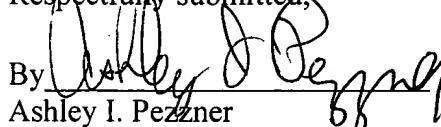
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the Interview Summary contained within the Notice of Allowance dated March 1, 2004, the Examiner contacted the undersigned and discussed making the proposed changes listed in the Notice of Allowance. The undersigned agreed to the proposed changes.

The Director is hereby authorized to charge any deficiency in the fees filed, asserted to be filed or which should have been filed herewith (or with any paper hereafter filed in this application by this firm) to our Deposit Account No. 03-2775, under Order No. 05587-00318-US.

Respectfully submitted,

By 
Ashley I. Pezzner

Registration No.: 35,646
CONNOLLY BOVE LODGE & HUTZ LLP
1007 North Orange Street
P.O. Box 2207
Wilmington, Delaware 19899



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Application No. (if known): 09/931330

Attorney Docket No.: 05587-00318-US

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Communication In Response To Interview Summary.